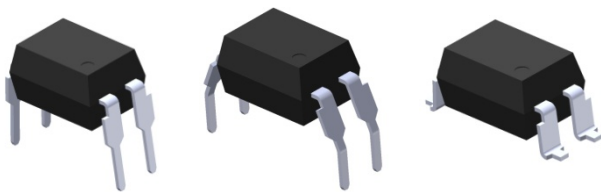
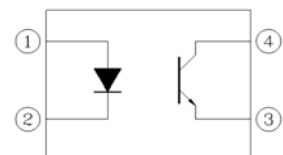


### 4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817-G Series



Schematic



Pin Configuration

1. Anode
2. Cathode
3. Emitter
4. Collector

#### Features:

- Halogens free.
- Current transfer ratio (CTR: 50~600% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$ )
- High isolation voltage between input and output (Viso=5000 V rms )
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- Compact small outline package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved
- CQC approved

#### Description

The EL817-G series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector encapsulated with green compound. The devices are in a 4-pin DIP package and available in wide-lead spacing and SMD option.

#### Applications

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

### Absolute Maximum Ratings (Ta=25°C)

|                                     | Parameter                         | Symbol    | Rating     | Unit  |
|-------------------------------------|-----------------------------------|-----------|------------|-------|
| Input                               | Forward current                   | $I_F$     | 60         | mA    |
|                                     | Peak forward current (1us, pulse) | $I_{FP}$  | 1          | A     |
|                                     | Reverse voltage                   | $V_R$     | 6          | V     |
|                                     | Power Dissipation                 | $P_D$     | 100        | mW    |
|                                     |                                   |           | 2.9        | mW/°C |
| Output                              | Break Down Voltage                | $P_C$     | 150        | mW    |
|                                     |                                   |           | 5.8        | mW/°C |
|                                     | Collector current                 | $I_C$     | 50         | mA    |
|                                     | Collector-Emitter voltage         | $V_{CEO}$ | 80         | V     |
|                                     | Emitter-Collector voltage         | $V_{ECO}$ | 7          | V     |
| Total Power Dissipation             |                                   | $P_{TOT}$ | 200        | mW    |
| Isolation Voltage* <sup>1</sup>     |                                   | $V_{ISO}$ | 5000       | V rms |
| Operating Temperature               |                                   | $T_{OPR}$ | -55 to 110 | °C    |
| Storage Temperature                 |                                   | $T_{STG}$ | -55 to 125 | °C    |
| Soldering Temperature* <sup>2</sup> |                                   | $T_{SOL}$ | 260        | °C    |

**Notes:**

\*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

\*2 For 10 seconds

**Electro-Optical Characteristics (Ta=25°C unless specified otherwise)**

**Input**

| Parameter         | Symbol   | Min. | Typ. | Max. | Unit          | Condition                |
|-------------------|----------|------|------|------|---------------|--------------------------|
| Forward Voltage   | $V_F$    | -    | 1.2  | 1.4  | V             | $I_F = 20\text{mA}$      |
| Reverse Current   | $I_R$    | -    | -    | 10   | $\mu\text{A}$ | $V_R = 4\text{V}$        |
| Input capacitance | $C_{in}$ | -    | 30   | 250  | pF            | $V = 0, f = 1\text{kHz}$ |

**Output**

| Parameter                           | Symbol     | Min | Typ. | Max. | Unit | Condition                               |
|-------------------------------------|------------|-----|------|------|------|-----------------------------------------|
| Collector-Emitter dark current      | $I_{CEO}$  | -   | -    | 100  | nA   | $V_{CE} = 20\text{V}, I_F = 0\text{mA}$ |
| Collector-Emitter breakdown voltage | $BV_{CEO}$ | 80  | -    | -    | V    | $I_C = 0.1\text{mA}$                    |
| Emitter-Collector breakdown voltage | $BV_{ECO}$ | 7   | -    | -    | V    | $I_E = 0.1\text{mA}$                    |

**Transfer Characteristics**

| Parameter                            | Symbol        | Min                | Typ. | Max. | Unit          | Condition                                                                |
|--------------------------------------|---------------|--------------------|------|------|---------------|--------------------------------------------------------------------------|
| Current Transfer ratio               | EL817         | 50                 | -    | 600  | %             | $I_F = 5\text{mA}, V_{CE} = 5\text{V}$                                   |
|                                      | EL817A        | 80                 | -    | 160  |               |                                                                          |
|                                      | EL817B        | 130                | -    | 260  |               |                                                                          |
|                                      | EL817C        | 200                | -    | 400  |               |                                                                          |
|                                      | EL817D        | 300                | -    | 600  |               |                                                                          |
|                                      | EL817X        | 100                | -    | 200  |               |                                                                          |
|                                      | EL817Y        | 150                | -    | 300  |               |                                                                          |
| Collector-Emitter saturation voltage | $V_{CE(sat)}$ | -                  | 0.1  | 0.2  | V             | $I_F = 20\text{mA}, I_C = 1\text{mA}$                                    |
| Isolation resistance                 | $R_{IO}$      | $5 \times 10^{10}$ | -    | -    | $\Omega$      | $V_{IO} = 500\text{Vdc}$ ,<br>40~60% R.H.                                |
| Floating capacitance                 | $C_{IO}$      | -                  | 0.6  | 1.0  | pF            | $V_{IO} = 0, f = 1\text{MHz}$                                            |
| Cut-off frequency                    | $f_c$         | -                  | 80   | -    | kHz           | $V_{CE} = 5\text{V}, I_C = 2\text{mA}$<br>$R_L = 100\Omega, -3\text{dB}$ |
| Rise time                            | $t_r$         | -                  | 6    | 18   | $\mu\text{s}$ | $V_{CE} = 2\text{V}, I_C = 2\text{mA}$ ,<br>$R_L = 100\Omega$            |
| Fall time                            | $t_f$         | -                  | 8    | 18   | $\mu\text{s}$ |                                                                          |

\* Typical values at  $T_a = 25^\circ\text{C}$

## Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

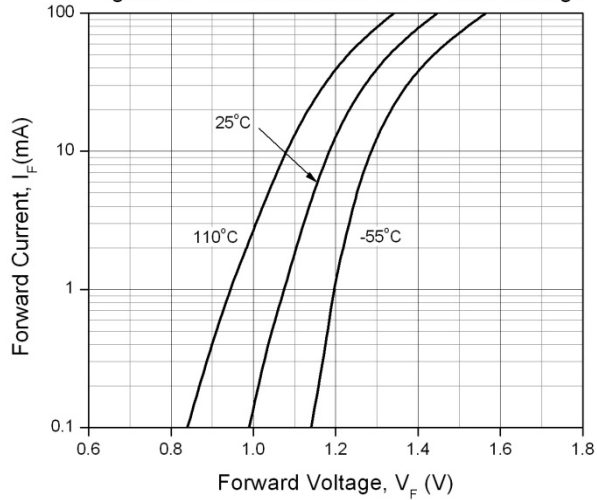


Figure 2. Normalized Current Transfer Ratio vs Forward Current

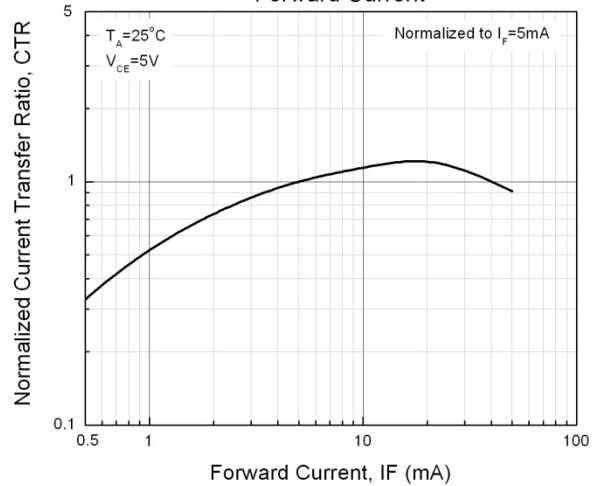


Figure 3. Current Transfer Ratio vs Ambient Temperature

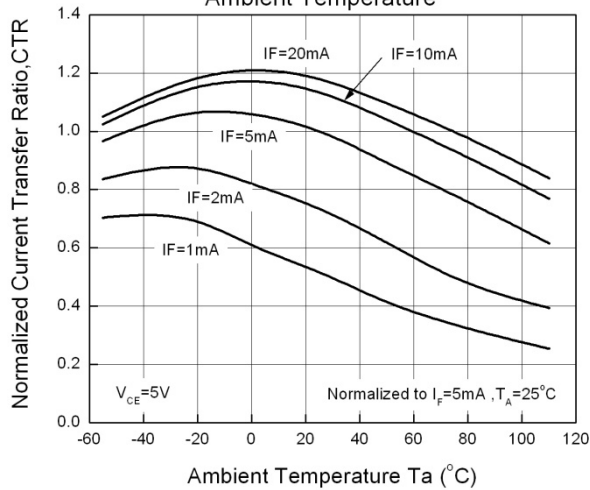


Figure 4. Dark Current vs Ambient Temperature

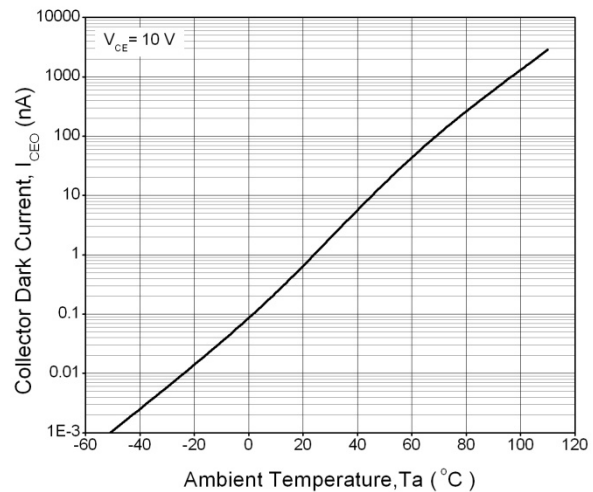


Figure 5. Collector-Emitter Saturation Voltage vs Collector Current

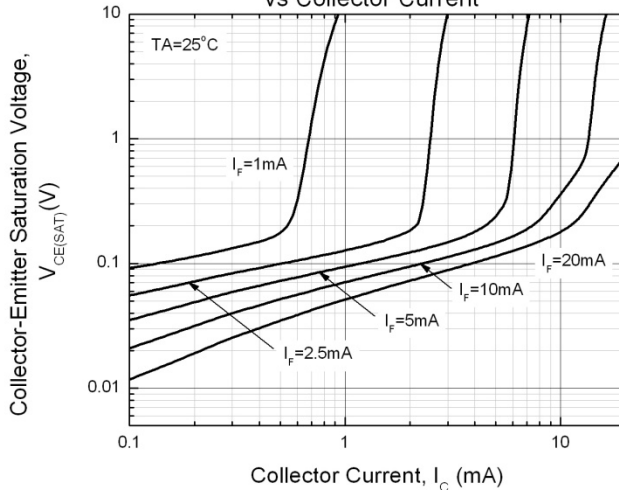
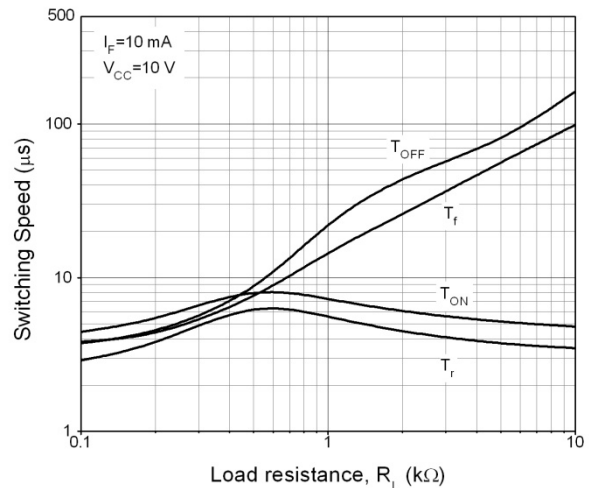


Figure 6. Switching Time vs Load Resistance



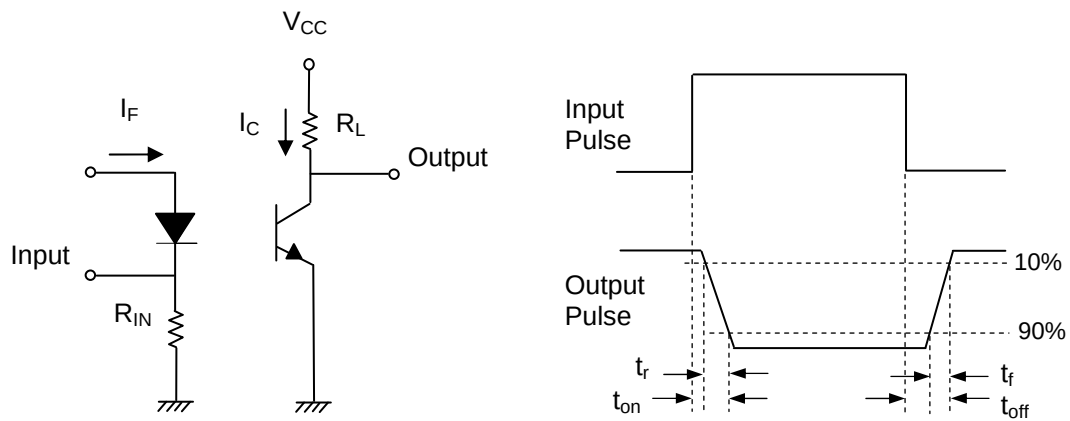


Figure 7. Switching Time Test Circuit & Waveforms

## Order Information

### Part Number

**EL817X(Y)(Z)-FVG**

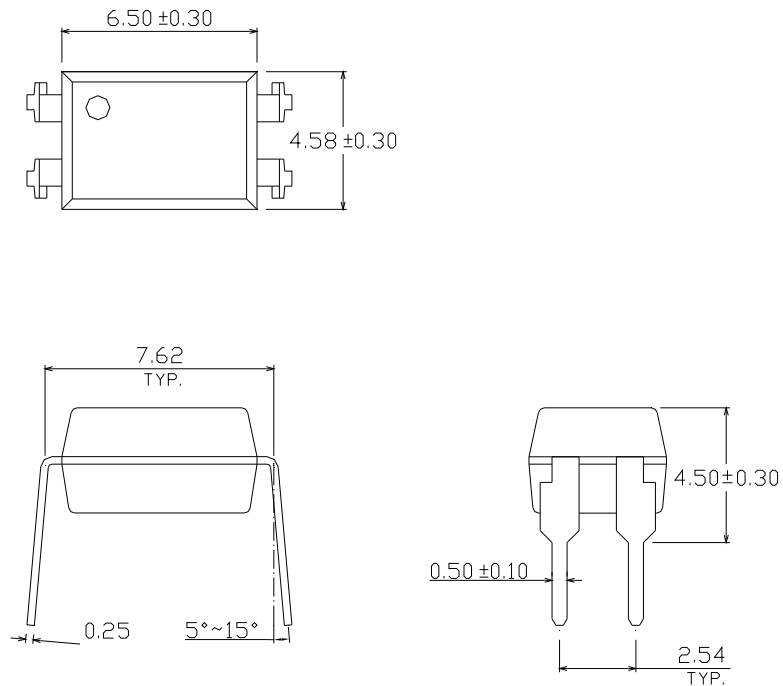
### Note

- X = Lead form option (S, S1, S2, M or none)  
Y = CTR Rank (A, B, C, D, X, Y or none)  
Z = Tape and reel option (TA, TB, TU, TD or none).  
F = Lead frame option (F: Iron, None: copper)  
V = VDE safety (optional).  
G = Halogens free

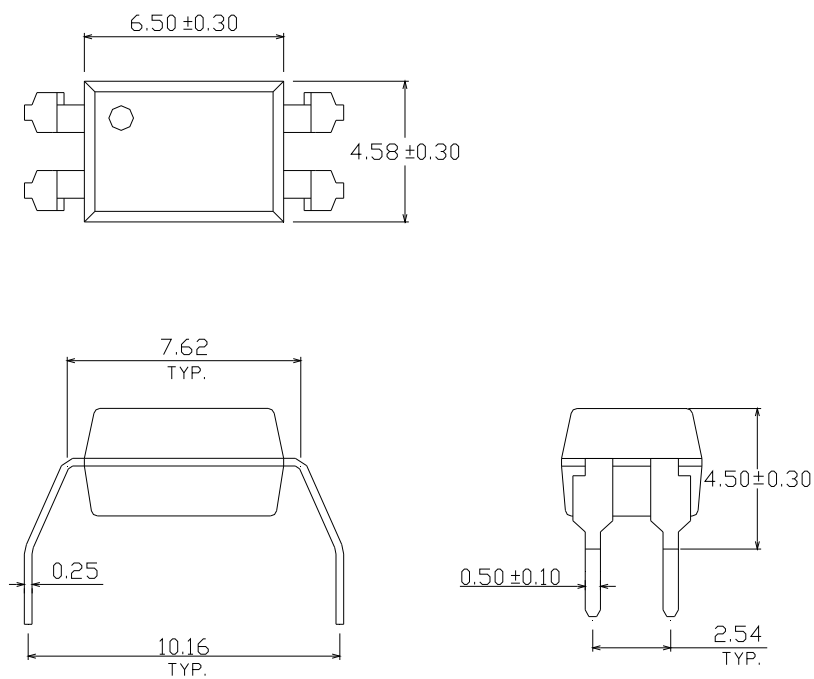
| Option  | Description                                                   | Packing quantity    |
|---------|---------------------------------------------------------------|---------------------|
| None    | Standard DIP-4                                                | 100 units per tube  |
| M       | Wide lead bend (0.4 inch spacing)                             | 100 units per tube  |
| S (TA)  | Surface mount lead form + TA tape & reel option               | 1000 units per reel |
| S (TB)  | Surface mount lead form + TB tape & reel option               | 1000 units per reel |
| S1 (TA) | Surface mount lead form (low profile) + TA tape & reel option | 1000 units per reel |
| S1 (TB) | Surface mount lead form (low profile) + TB tape & reel option | 1000 units per reel |
| S2 (TA) | Surface mount lead form (Gull-wing) + TA tape & reel option   | 500 units per reel  |
| S2 (TB) | Surface mount lead form (Gull-wing) + TB tape & reel option   | 500 units per reel  |
| S (TU)  | Surface mount lead form + TU tape & reel option               | 1500 units per reel |
| S (TD)  | Surface mount lead form + TD tape & reel option               | 1500 units per reel |
| S1 (TU) | Surface mount lead form (low profile) + TU tape & reel option | 1500 units per reel |
| S1 (TD) | Surface mount lead form (low profile) + TD tape & reel option | 1500 units per reel |

## Package Dimension (Dimensions in mm)

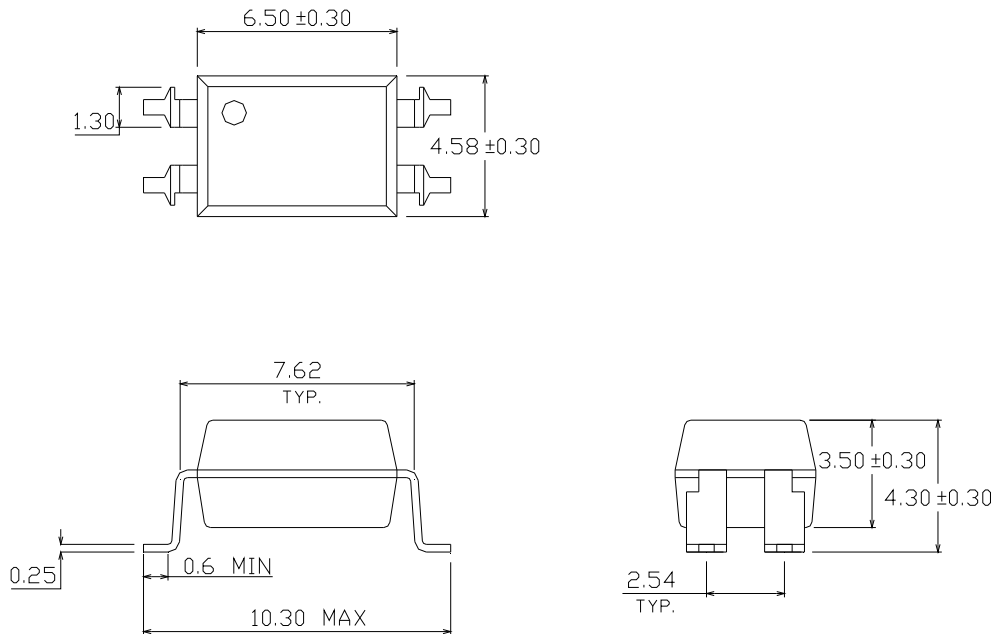
### Standard DIP Type



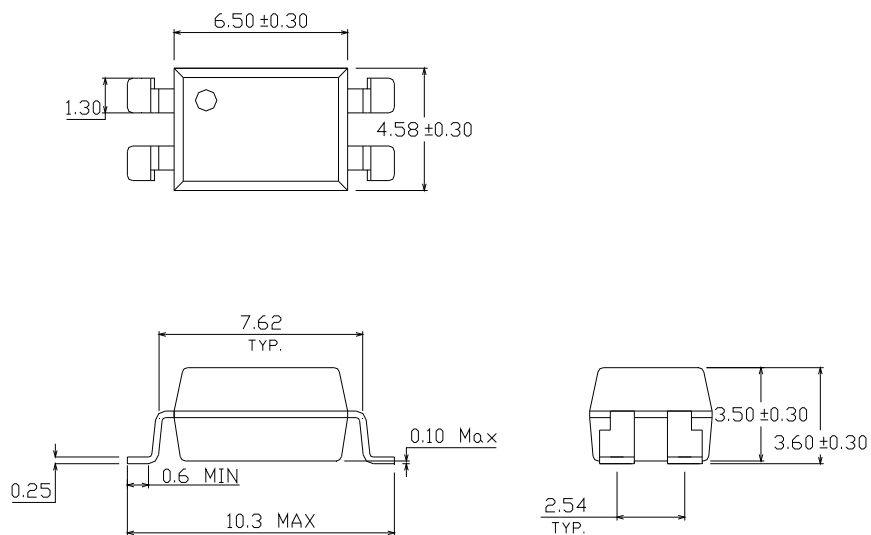
### Option M Type



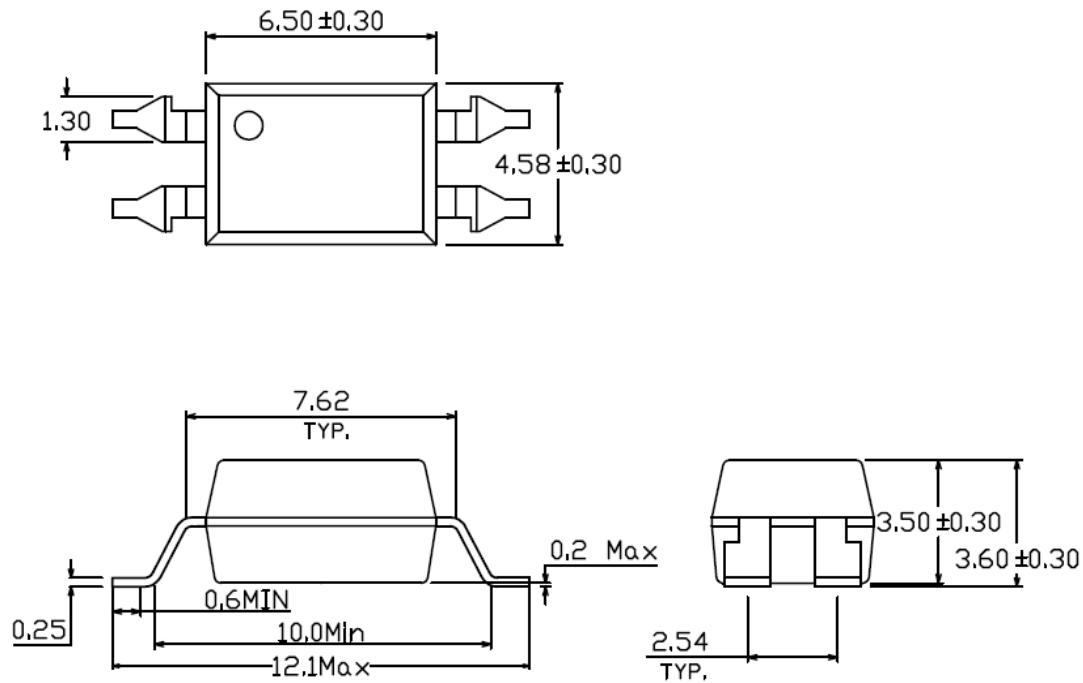
### Option S Type



### Option S1 Type

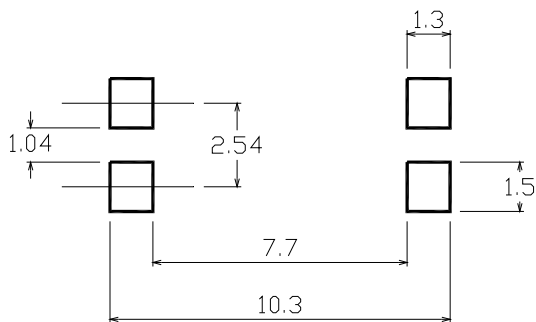


Option S2 Type

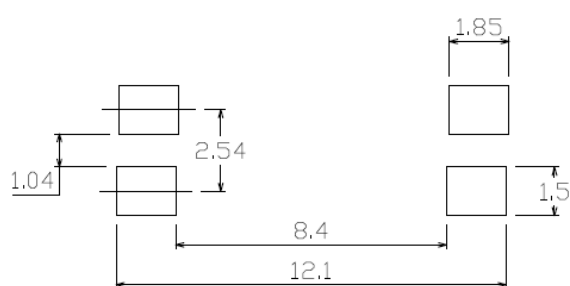


Recommended pad layout for surface mount leadform

For S and S1 option



For S2 option



## Device Marking

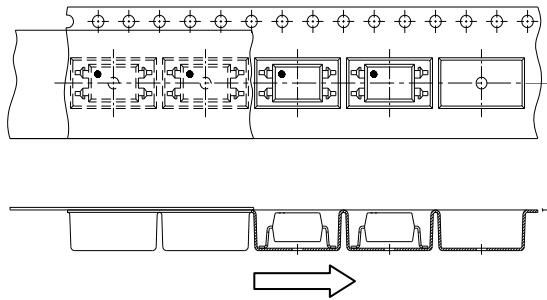


## Notes

|     |                                       |
|-----|---------------------------------------|
| EL  | denotes EVERLIGHT                     |
| 817 | denotes Device Number                 |
| R   | denotes CTR Rank (A, B, C, D or none) |
| Y   | denotes 1 digit Year code             |
| WW  | denotes 2 digit Week code             |
| V   | denotes VDE (optional)                |

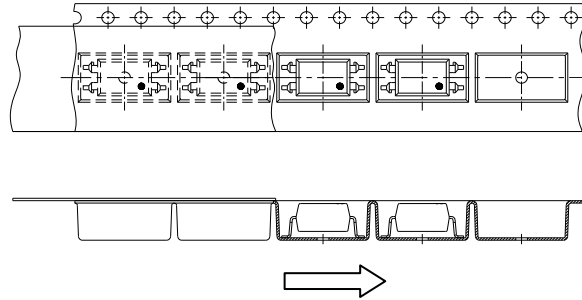
## Tape & Reel Packing Specifications

**Option TA**



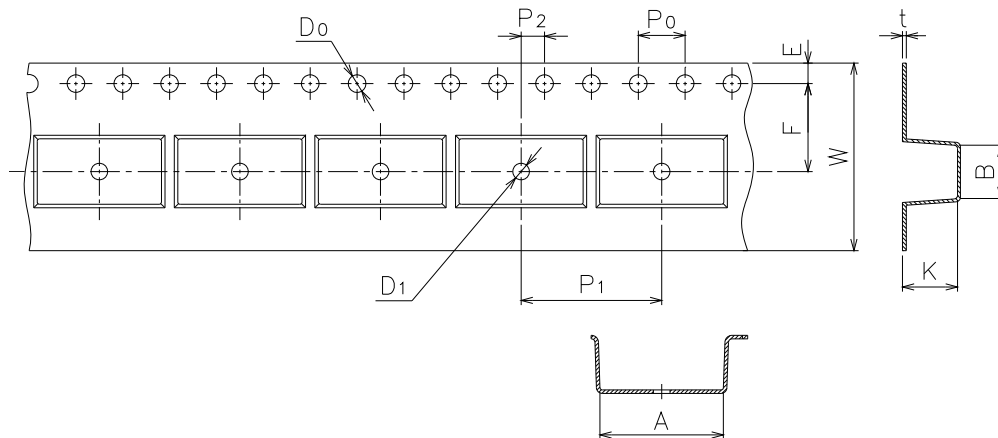
Direction of feed from reel

**Option TB**



Direction of feed from reel

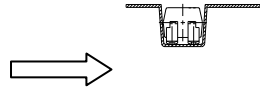
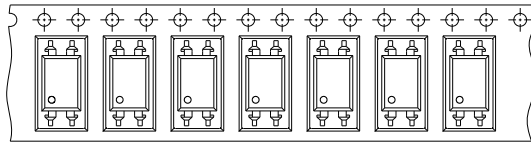
## Tape dimensions



## Tape dimensions

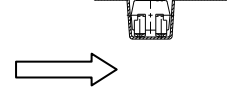
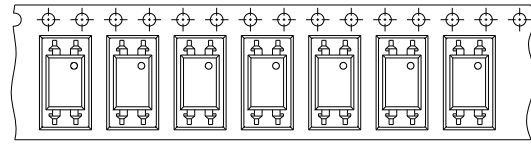
| Dimension No.        | A         | B        | Do       | D1       | E        | F        |
|----------------------|-----------|----------|----------|----------|----------|----------|
| Dimension (mm)       | 10.5±0.1  | 4.65±0.1 | 1.55±0.1 | 1.50±0.1 | 1.75±0.1 | 7.5±0.1  |
| Dimension (mm)<br>S2 | 12.15±0.1 | 4.65±0.1 | 1.55±0.1 | 1.50±0.1 | 1.75±0.1 | 7.5±0.1  |
| Dimension No.        | Po        | P1       | P2       | t        | W        | K        |
| Dimension (mm)       | 4.0±0.1   | 12.0±0.1 | 2.0±0.1  | 0.35±0.1 | 16.0±0.3 | 4.75±0.1 |
| Dimension (mm)<br>S2 | 4.0±0.1   | 16.0±0.1 | 2.0±0.1  | 0.35±0.1 | 16.0±0.3 | 3.90±0.1 |

**Option TD**



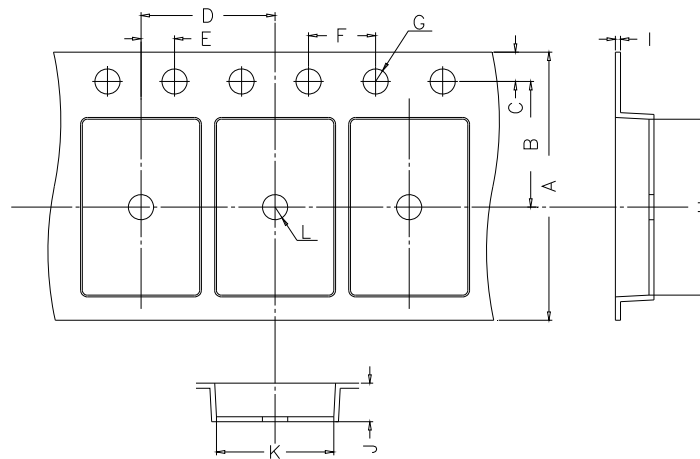
Direction of feed from reel

**Option TU**



Direction of feed from reel

**Tape dimensions**

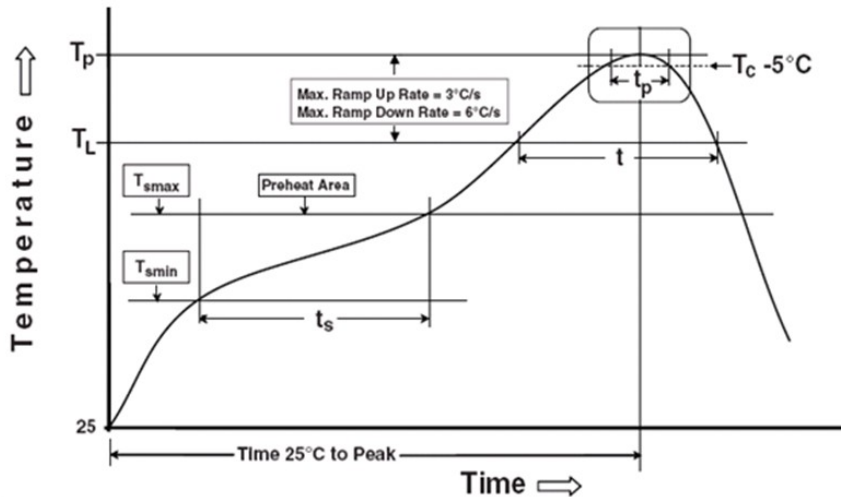


| Dimension No. | <b>A</b>  | <b>B</b> | <b>C</b> | <b>D</b> | <b>E</b> | <b>F</b>  |
|---------------|-----------|----------|----------|----------|----------|-----------|
| Dimension(mm) | 16.00±0.3 | 7.5±0.1  | 1.75±0.1 | 8.0±0.1  | 2.0±0.1  | 4.0±0.1   |
| Dimension No. | <b>G</b>  | <b>H</b> | <b>I</b> | <b>J</b> | <b>K</b> | <b>L</b>  |
| Dimension(mm) | 1.55±0.05 | 10.4±0.1 | 0.4±0.05 | 4.60±0.1 | 5.1±0.1  | 1.55±0.05 |

## Precautions for Use

### 1. Soldering Condition

#### 1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

#### Preheat

|                                                                  |                 |
|------------------------------------------------------------------|-----------------|
| Temperature min (T <sub>smin</sub> )                             | 150 °C          |
| Temperature max (T <sub>smax</sub> )                             | 200°C           |
| Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> ) | 60-120 seconds  |
| Average ramp-up rate (T <sub>smax</sub> to T <sub>p</sub> )      | 3 °C/second max |

#### Other

|                                                                   |                  |
|-------------------------------------------------------------------|------------------|
| Liquidus Temperature (T <sub>L</sub> )                            | 217 °C           |
| Time above Liquidus Temperature (t <sub>L</sub> )                 | 60-100 sec       |
| Peak Temperature (T <sub>p</sub> )                                | 260°C            |
| Time within 5 °C of Actual Peak Temperature: T <sub>p</sub> - 5°C | 30 s             |
| Ramp- Down Rate from Peak Temperature                             | 6°C /second max. |
| Time 25°C to peak temperature                                     | 8 minutes max.   |
| Reflow times                                                      | 3 times          |

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